



N Channel 100 V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | |
|--------------------------|---|--------------------|----------------------|--|--|--|
| V _{(BR)DSS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) | Q _g (Typ) | | | |
| 100 | $0.0082 \text{ at V}_{GS} = 10 \text{ V}$ | 90 ^d | 97 | | | |

TO-263

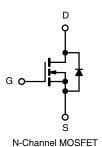
FEATURES

- TrenchFET® Power MOSFETS
- 175 °C Junction Temperature
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

- Power Supply
 - Secondary Synchronous Rectification
- Industrial
- Primary Switch



Ordering Information: SUM90N10-8m2P-E3 (Lead (Pb)-free)

Top View

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | | |
|---|-------------------------------------|-----------------|------------------|-----|--|--|
| Parameter | Symbol | Limit | Unit | | | |
| Drain-Source Voltage | V _{DS} | 100 | v | | | |
| Gate-Source Voltage | V _{GS} | ± 20 |] | | | |
| Continuous Drain Current (T _{.1} = 175 °C) | T _C = 25 °C | I _D | 90 ^d | A | | |
| Continuous Diain Current (1) = 173 C) | T _C = 70 °C | d 'p | 90 ^d | | | |
| Pulsed Drain Current | I _{DM} | 240 | A | | | |
| Avalanche Current | I _{AS} | 60 | | | | |
| Single Avalanche Energy ^a | L = 0.1 mH | E _{AS} | 180 | mJ | | |
| Mariana Barra Biraira kirad | T _C = 25 °C | В | 300 ^b | 14/ | | |
| Maximum Power Dissipation ^a | T _A = 25 °C ^c | $ P_D$ | 3.75 | W | | |
| Operating Junction and Storage Temperature R | T _J , T _{stg} | - 55 to 175 | °C | | | |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|-------------------|-------|------|--|--|
| Parameter | Symbol | Limit | Unit | | |
| Junction-to-Ambient (PCB Mount) ^c | R _{thJA} | 40 | °C/W | | |
| Junction-to-Case (Drain) | R _{thJC} | 0.5 | C/VV | | |

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Package limited.

SUM90N10-8m2P

Vishay Siliconix



| SPECIFICATIONS (T _J = 25 °C, unless otherwise noted) | | | | | | | |
|--|----------------------|--|------|--------|--------|-------|--|
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | $V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$ | 100 | | | 4.5 V | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 2.5 | | 4.5 | | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 250 | nA | |
| | | V _{DS} = 100 V, V _{GS} = 0 V | | | 1 | μΑ | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$ | | | 50 | | |
| | | V _{DS} = 100 V, V _{GS} = 0 V, T _J = 150 °C | | | 250 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$ | 70 | | | Α | |
| Durin Course On Olate Basistana a | B | V _{GS} = 10 V, I _D = 20 A | | 0.0067 | 0.0082 | Ω | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C | | 0.0127 | 0.0170 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 20 A | | 62 | | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | | 6290 | | pF | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 \text{ V}, V_{DS} = 50 \text{ V}, f = 1 \text{ MHz}$ | | 535 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 182 | | | |
| Total Gate Charge ^c | Qg | | | 97 | 150 | | |
| Gate-Source Charge ^c | Q _{gs} | $V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 85 \text{ A}$ | | 32 | | nC | |
| Gate-Drain Charge ^c | Q_{gd} | | | 25 | | | |
| Gate Resistance | R _g | f = 1 MHz | 0.28 | 1.4 | 2.8 | Ω | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 23 | 35 | | |
| Rise Time ^c | t _r | $V_{DD} = 50 \text{ V}, R_{L} = 0.588 \Omega$ | | 17 | 26 | 20 | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D \cong 85 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$ | | 34 | 52 | ns | |
| Fall Time ^c | t _f | | | 9 | 18 | | |
| Source-Drain Diode Ratings and Ch | aracteristics (| T _C = 25 °C) ^b | | | | | |
| Continuous Current | Is | | | | 85 | А | |
| Pulsed Current | I _{SM} | | | | 240 | | |
| Forward Voltage ^a | V _{SD} | I _F = 30 A, V _{GS} = 0 V | | 0.85 | 1.5 | V | |
| Reverse Recovery Time | t _{rr} | | | 61 | 100 | ns | |
| Peak Reverse Recovery Current | I _{RM(REC)} | I _F = 75 A, di/dt = 100 A/μs | | 3 | 4.5 | Α | |
| Reverse Recovery Charge | Q _{rr} | | | 91 | 130 | μC | |

Notes:

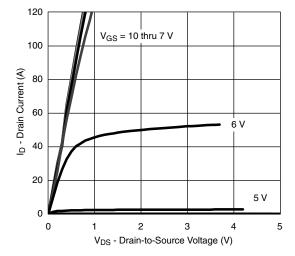
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

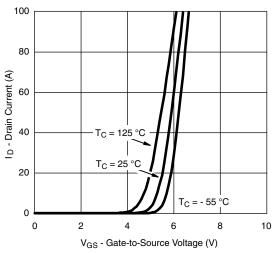




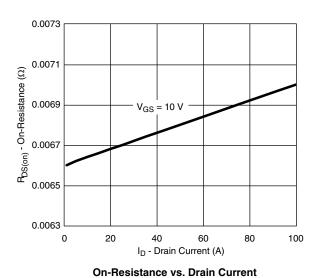
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Output Characteristics



Transfer Characteristics



150 150 T_C = -55 °C T_C = 25 °C T_C = 125 °C

0

0

12

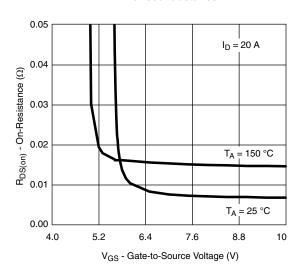
I_D - Drain Current (A) **Transconductance**

36

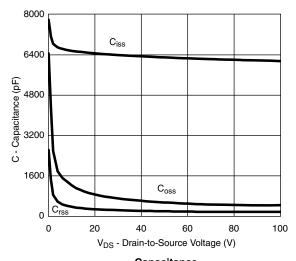
48

60

24



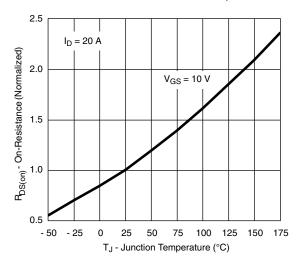
On-resistance vs. Gate-to-Source Voltage



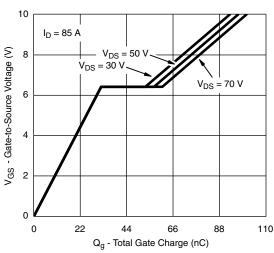
Capacitance

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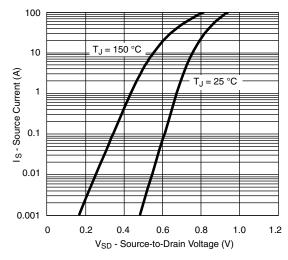
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



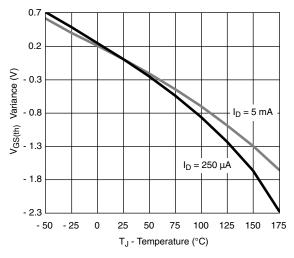
On-Resistance vs. Junction Temperature



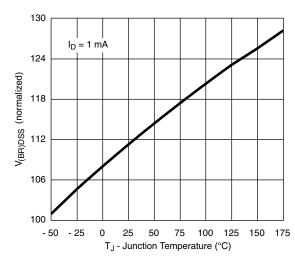
Gate Charge



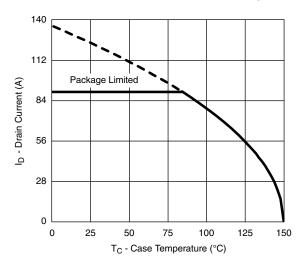
Source-Drain Diode Forward Voltage



Threshold Voltage



Drain Source Breakdown vs. Junction Temperature

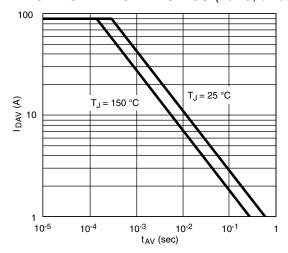


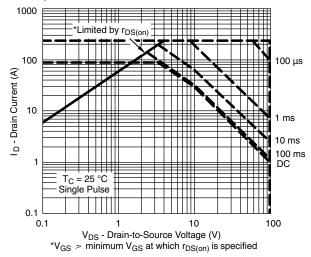
Maximum Drain Current vs. Case Temperature



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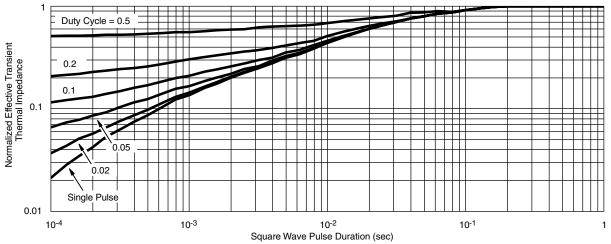
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Single Pulse Avalanche Current Capability vs. Time



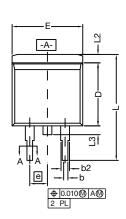


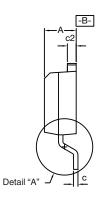
Normalized Thermal Transient Impedance, Junction-to-Case

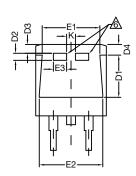
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TO-263 (D²PAK): 3-LEAD









DETAIL A (ROTATED 90°)



| _ 1 | b | |
|-----|-----------------|---|
| 27 | ਹ <i>ੀ </i> | |
| c | SECTION A-4 | 1 |

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6 This feature is for thick lead.

| DIM. | | INC | HES | MILLIMETERS | | |
|---------------------------------|------------|-----------|-------|-------------|--------|--|
| | | MIN. | MAX. | MIN. | MAX. | |
| Α | | 0.160 | 0.190 | 4.064 | 4.826 | |
| | b | 0.020 | 0.039 | 0.508 | 0.990 | |
| | b1 | 0.020 | 0.035 | 0.508 | 0.889 | |
| | b2 | 0.045 | 0.055 | 1.143 | 1.397 | |
| c* | Thin lead | 0.013 | 0.018 | 0.330 | 0.457 | |
| C | Thick lead | 0.023 | 0.028 | 0.584 | 0.711 | |
| c1 | Thin lead | 0.013 | 0.017 | 0.330 | 0.431 | |
| CI | Thick lead | 0.023 | 0.027 | 0.584 | 0.685 | |
| | c2 | 0.045 | 0.055 | 1.143 | 1.397 | |
| | D | 0.340 | 0.380 | 8.636 | 9.652 | |
| | D1 | 0.220 | 0.240 | 5.588 | 6.096 | |
| | D2 | 0.038 | 0.042 | 0.965 | 1.067 | |
| | D3 | 0.045 | 0.055 | 1.143 | 1.397 | |
| | D4 | 0.044 | 0.052 | 1.118 | 1.321 | |
| | Е | 0.380 | 0.410 | 9.652 | 10.414 | |
| | E1 | 0.245 | - | 6.223 | = | |
| | E2 | 0.355 | 0.375 | 9.017 | 9.525 | |
| | E3 | 0.072 | 0.078 | 1.829 | 1.981 | |
| е | | 0.100 |) BSC | 2.54 BSC | | |
| K | | 0.045 | 0.055 | 1.143 | 1.397 | |
| L | | 0.575 | 0.625 | 14.605 | 15.875 | |
| L1 | | 0.090 | 0.110 | 2.286 | 2.794 | |
| L2 | | 0.040 | 0.055 | 1.016 | 1.397 | |
| L3 | | 0.050 | 0.070 | 1.270 | 1.778 | |
| L4 | | 0.010 BSC | | 0.254 BSC | | |
| | М | - | 0.002 | - | 0.050 | |
| ECN: T13-0707-Rev. K, 30-Sep-13 | | | | | | |

DWG: 5843





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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Revision: 02-Oct-12 Document Number: 91000

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